VXG M9384B and VXG-m M9383B

Microwave Signal Generators, 1 MHz to 44 GHz

This data sheet provides key features and specifications for the M9384B VXG and M9383B VXG-m microwave signal generators.





DATA SHEET

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Definitions and Conditions

Specification (spec)

Specifications represent warranted performance of a calibrated instrument that has been stored for a minimum of 2 hours within the operating temperature range of 0 to 40 °C, unless otherwise stated, and after a 45-minute warm-up period. All Specifications apply over a 20 °C to 30 °C temperature range (unless otherwise stated). Specifications include guard bands to account for the expected statistical performance distribution, measurement uncertainties, and changes in performance due to environmental conditions. Data represented in this document are Specifications unless otherwise noted.

Typical (typ)

Typical describes additional product performance information that is not covered by the product warranty. It is performance beyond specifications that 80 percent of the units exhibit with a 90 percent confidence level at room temperature (approximately 23 °C). Typical performance does not include measurement uncertainty.

Nominal (nom)

Nominal values indicate the expected mean or average performance, or an attribute whose performance is by design, such as the 50-ohm connector. This data is not warranted and is measured at room temperature (approximately 23 °C).

Measured (meas)

Measured describes an attribute measured during the design phase for purposes of communicating expected performance, such as amplitude drift vs. time. This data is not warranted and is measured at room temperature (approximately 23 °C).

Block diagram

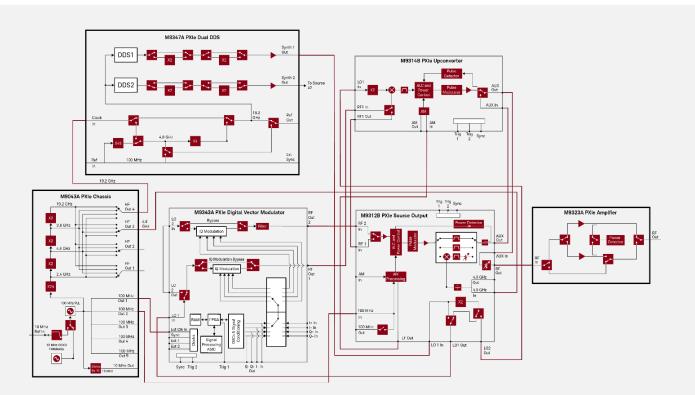
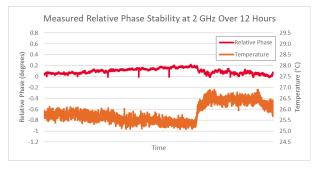


Figure 1: Block diagram for the VXG, a 44 GHz signal generator with 2 GHz RF bandwidth.

Frequency

Range				
Option F14 ¹	1 MHz to 14 GHz			
Option F20 ¹	1 MHz to 20 GHz			
Option F32 ¹	1 MHz to 31.8 GHz			
Option F44	1 MHz to 44 GHz			
Resolution	0.01 Hz			
Phase adjustments				
Phase offset range	± 180 degrees			
Phase offset resolution	0.001 degrees			
Relative phase adjustm	ents: channel 1 versus channel 2 (option PCH)			
Relative phase offset range	± 180 degrees			
Relative phase offset resolution	0.001 degree			
Relative phase repeatability ²	0.0001 degree (nom.)			





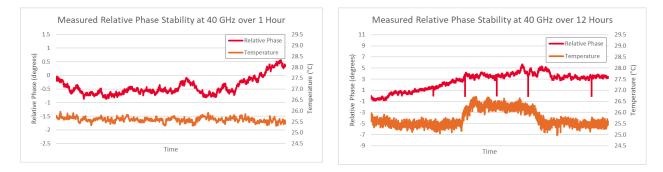


Figure 2: Relative phase stability between VXG channel 1 and channel 2 measured in an office environment.

¹ Available on M9384B only.

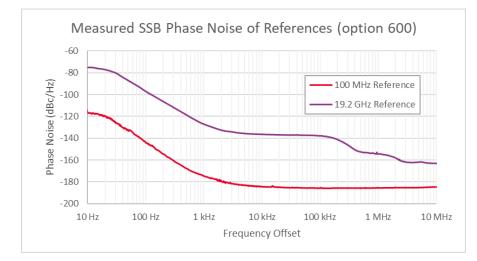
 $^{^2}$ When tuning frequency from f_1 to f_2 and back to f_1 .

Frequency Reference

	Reference Outputs		
	100 MHz out		
Amplitude ³ \geq 10 dBm, 15 dBm (typ.)			
Connector	SMB male (M9383B), SMA female (M9384B)		
Impedance	50 Ω (nom.)		
	10 MHz out		
Amplitude ³	≥ 10 dBm, 13 dBm (typ.)		
Connector	SMB male (M9383B), BNC female (M9384B)		
Impedance	50 Ω (nom.)		
19.2 GHz out			
Amplitude ³	> 0 dBm, 1 dBm (typ.)		
Connector	SMA female		
Impedance	50 Ω (nom.)		
	External reference input		
Frequency	10 MHz or 100 MHz		
Lock range	± 0.6 ppm (nom.)		
Amplitude	-3 dBm to 20 dBm		
Connector	SMB male (M9383B), BNC female (M9384B)		
Impedance	50 Ω (nom.)		

³ Does not include a guard band for performance distribution, measurement uncertainty, or environmental variations.

Frequency accuracy					
		± (time since last adjustment x aging rate)			
Calculation		± temperature effects			
		± calibration accuracy			
	Daily	< ± 0.5 ppb/day, after 72-hour warm-up			
Aging rate ⁴	Yearly	< ± 0.1 ppm/year, after 72-hour warm-up			
	Total 10 years	< ± 0.6 ppm/10yrs, after 72-hour warm-up			
Temperature effects	20 to 30 °C	< ± 10 ppb			
(nom.)	Full temperature range	< ± 50 ppb			
Initial achievable calibration	on accuracy ⁵	± 5 x 10 ⁻⁸			
Warm up (nom.)					
5 minutes over +20 to +30) °C, with respect to 1 hour	< ± 0.1 ppm			
15 minutes over +20 to +3	30 °C, with respect to 1 hour	< ± 0.01 ppm			



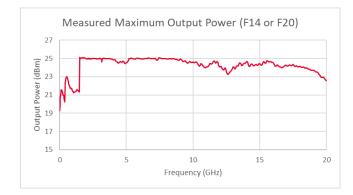
Not verified by Keysight N7800A TME Calibration and Adjustment Software. Daily aging rate may be verified as a supplementary chargeable service, on request. At time of shipment. Δ

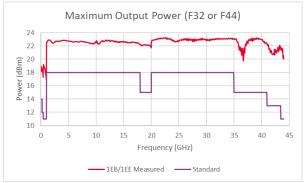
Power

ο	utput parameters
Settable range	-120 dBm to +23 dBm
Resolution	0.01 dB
Output impedance	50 Ω (nom.)
Maximum reverse power	1/2 Watt, 0 VDC, nominal
Maximum	output power ⁶ () = typical
Op	tions F14 and F20
Frequency range	Standard
10 MHz to < 200 MHz (harmonic filters off)	+18 dBm (+21 dBm)
10 MHz to < 200 MHz (harmonic filters on)	+18 dBm (+21 dBm)
200 MHz to < 400 MHz (harmonic filters off)	+19 dBm (+20 dBm)
200 MHz to < 400 MHz (harmonic filters on)	+13 dBm (+16 dBm)
400 MHz to < 1 GHz (harmonic filters off)	+20 dBm (+21 dBm)
400 MHz to < 1 GHz (harmonic filters on)	+14 dBm (+17 dBm)
1 GHz to < 1.1 GHz (harmonic filters off)	+20 dBm (+21 dBm)
1 GHz to < 1.1 GHz (harmonic filters on)	+11 dBm (+13 dBm)
1.1 GHz to < 1.5 GHz (harmonic filters off)	+19 dBm (+21 dBm)
1.1 GHz to < 1.5 GHz (harmonic filters on)	+15 dBm (+18 dBm)
1.5 GHz to < 10 GHz	+21 dBm (+23 dBm)
10 GHz to < 17 GHz	+20 dBm (+22 dBm)
17 GHz to 20 GHz	+19 dBm (+21 dBm)

⁶ With option 1EH harmonic filters below 2 GHz switched off, unless otherwise specified.

Maximum	output power ⁷ () = typical						
Op	Options F32 and F44						
Frequency range	Standard	Option 1EB ⁸ or 1EE					
10 MHz to < 200 MHz (harmonic filters off)	+14 dBm	+15 dBm (+18 dBm)					
10 MHz to < 200 MHz (harmonic filters on)	+13 dBm	+15 dBm (+18 dBm)					
200 MHz to < 400 MHz (harmonic filters off)	+12 dBm	+14 dBm (+17 dBm)					
200 MHz to < 400 MHz (harmonic filters on)	+8 dBm	+10 dBm (+13 dBm)					
400 MHz to < 1 GHz (harmonic filters off)	+11 dBm	+14 dBm (+17 dBm)					
400 MHz to < 1 GHz (harmonic filters on)	+7 dBm	+10 dBm (+13 dBm)					
1 GHz to < 1.5 GHz (harmonic filters off)	+18 dBm	+20 dBm (+22 dBm)					
1 GHz to < 1.5 GHz (harmonic filters on)	+10 dBm	+20 dBm (+22 dBm)					
1.5 GHz to < 17 GHz	+18 dBm	+20 dBm (+22 dBm)					
17 GHz to < 20 GHz	+15 dBm	+19 dBm (+21 dBm)					
20 GHz to < 35 GHz	+18 dBm	+19 dBm (+21 dBm)					
35 GHz to < 37 GHz	+15 dBm	+17 dBm (+21 dBm)					
37 GHz to < 41 GHz	+15 dBm	+18 dBm (+21 dBm)					
41 GHz to 43.5 GHz	+13 dBm	+14 dBm (+19 dBm)					
> 43.5 GHz to 44 GHz	+11 dBm	+14 dBm (+18 dBm)					





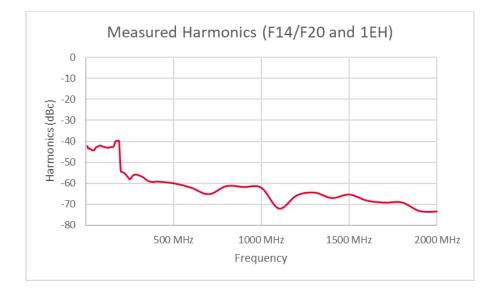
With option 1EH harmonic filters below 2 GHz switched off, unless otherwise specified. Expect a 1-2 dBm maximum output power improvement for M9383B. 8

		Absolu	ite level accuracy (CW	′) ⁹ , () = typical	
Frequency	> +5 dBm	า	+5 dBm to -40 dBm	-40 dBm to -80 dB	3m -80 dBm to -90 dBm
10 MHz to < 200 MHz	± 1.3 dB (± 0.4 dB)		± 1.3 dB (± 0.4 dB) ± 1.3 dB (± 0.3 dB		dB) ± 1.2 dB (± 0.3 dB)
200 MHz to < 400 MHz	± 1.1 dB (± 0.2 dB)		± 1.2 dB (±0.2 dB) ± 1.0 dB (± 0.3 d	dB) ± 1.1 dB (± 0.3 dB)
400 MHz to < 3.6 GHz	± 1.5 dB (± 0.	3 dB)	± 1.2 dB (±0.2 dB) ± 1.4 dB (± 0.4 d	dB) ± 2.8 dB (± 0.9 dB)
3.6 GHz to < 16 GHz	± 1.4 dB (± 0.	4 dB)	± 1.3 dB (±0.5 dB) ± 1.4 dB (±0.5 d	B) ± 1.7 dB (± 0.6 dB)
16 GHz to < 20 GHz	± 1.3 dB (± 0.	3 dB)	± 1.2 dB (± 0.3 dB	3) ±1.2 dB (± 0.4 d	B) ± 1.5 dB (± 0.5 dB)
20 GHz to < 34 GHz	± 1.5 dB (± 0.	4 dB)	± 1.8 dB (± 0.6 dB	B) ± 2.0 dB (± 1.0 d	dB) ± 2.0 dB (± 1.0 dB)
34 GHz to 44 GHz	± 1.6 dB (± 0.	4 dB)	± 1.9 dB (± 0.6 dB	B) ± 2.1 dB (± 0.8 d	dB) ± 2.4 dB (± 1.5 dB)
	Absolute leve	el accura	acy in IQ mode relative	to CW (-15 dBm to +4 d	dBm)
Frequency		Wavefo	rm type: 5G NR, SCS 1	20 kHz, 100 MHz BW, 2	56 QAM, 1CC
1 GHz to 44 GHz	± 0.7 dB (typ))			
			SWR (measured CW)	mode)	
Frequen	ю		ower range of gh-power path	High power path	Standard path
< 50 MHz		-		-	2.2:1
50 MHz to < 500	MHz	-		-	1.7:1
500 MHz to < 1 G	Hz	-		-	1.5:1
1 GHz to < 3.2 G	Ηz	≥ 10 dl	3m	1.8:1	1.5:1
3.2 GHz to < 11 G	GHz	≥ -3 dE	3m	1.5:1	1.7:1
11 GHz to < 20 G	Hz	≥ -3 dE	3m	1.4:1	1.4:1
20 GHz to < 30 G	Hz	≥ -3 dE	3m	2.3:1	2.6:1
30 GHz to < 39 G	Hz	≥ -3 dE	3m	1.9:1	2.2:1
39 GHz to 44 GHz			dBm	1.9:1	2.2:1

⁹ ALC On or using Power Search.

Spectral Purity

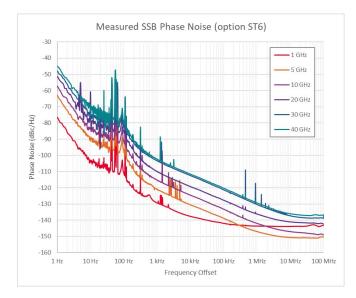
Harmonics ¹⁰ , () = typical, [] = measured					
	Harmonics measured in dBc at +5 dBm				
Frequency	Specified	Typical F32 & F44	Measured F14 & F20		
10 MHz to < 200 MHz (1EH harmonic filters off/on)	-27/-27	(-35/-35)	[-40/-40]		
200 MHz to < 300 MHz (1EH harmonic filters off/on)	-30/-43	(-36/-50)	[-39/-54]		
300 MHz to < 400 MHz (1EH harmonic filters off/on)	-33/-44	(-40/-52)	[-45/-56]		
400 MHz to < 2 GHz (1EH harmonic filters off/on)	-24/-46	(-31/-54)	[-36/-59]		
2 GHz to < 3.2 GHz	-44	(-53)	[-58]		
3.2 GHz to < 4.3 GHz	-31	(-39)	[-70]		
4.3 GHz to < 4.8 GHz	-19	(-28)	[-37]		
4.8 GHz to < 6.5 GHz	-29	(-36)	[-54]		
6.5 GHz to < 6.8 GHz	-18	(-26)	[-35]		
6.8 GHz to < 10 GHz	-26	(-32)	[-55]		
10 GHz to < 11.4 GHz	-26	(-32)	-		
11.4 GHz to < 17.1 GHz	-41	(-49)	-		
17.1 GHz to < 20 GHz	-45	(-53)	-		
20 GHz to 22 GHz	-29	(-36)	-		



¹⁰ For configurations which do not include option 1ES

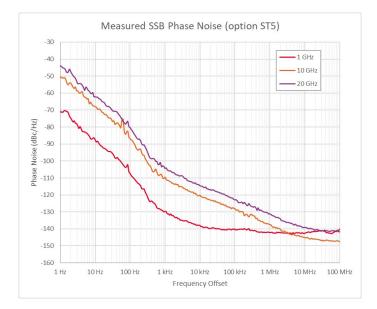
	Sub-harmonics () = typical
Frequency	Sub-harmonics measured at +9 dBm
10 MHz to < 50 MHz	-61 dBc (-77 dBc)
50 MHz to < 200 MHz	-82 dBc (-89 dBc)
200 MHz to < 210 MHz	-60 dBc (-67 dBc)
210 MHz to < 2 GHz	-81 dBc (-87 dBc)
2 GHz to < 2.45 GHz	-59 dBc (-69 dBc)
2.45 GHz to < 6 GHz	-81 dBc (-89 dBc)
6 GHz to < 9.5 GHz	-45 dBc (-75 dBc)
9.5 GHz to < 11 GHz	-38 dBc (-55 dBc)
11 GHz to < 12 GHz	-63 dBc (-73 dBc)
12 GHz to < 19 GHz	-36 dBc (-50 dBc)
19 GHz to < 19.5 GHz	-30 dBc (-47 dBc)
19.5 GHz to 44 GHz	-69 dBc (-80 dBc)
	Non-harmonics () = typical
Frequency	Non-harmonics measured at +10 dBm
10 MHz to < 400 MHz	-43 dBc (-52 dBc)
400 MHz to < 17.7 GHz	-50 dBc (-61 dBc)
17.7 GHz to < 27 GHz	-42 dBc (-54 dBc)
27 GHz to < 40 GHz	-36 dBc (-47 dBc)
40 GHz to 44 GHz	-42 dBc (-54 dBc)

	Absolute SS	B pha	se noise (CW)	(dBc/Hz) (o	option ST	6), () = typical		
Frequency	1 Hz		10 Hz	100	Hz	1 kHz		10 kHz
≤ 100 MHz	-81 (-90)	-10	2 (-108)	-114 (-1	19)	-125 (-131)		-132 (-136)
≤ 250 MHz	-75 (-83)	-97	(-104)	-108 (-1	14)	-121 (-127)		-130 (-135)
≤ 500 MHz	-71 (-78)	-96	(-104)	-106 (-1	13)	-128 (-134)		-134 (-139)
≤ 1 GHz	-65 (-73)	-88	(-97)	-100 (-1	07)	-125 (-132)		-133 (-137)
≤ 2 GHz	-59 (-66)	-84	(-92)	-94 (-10)1)	-121 (-128)		-131 (-136)
≤ 3.2 GHz	-54 (-61)	-79	(-87)	-88 (-96	5)	-117 (-124)		-127 (-132)
≤ 10 GHz	-42 (-51)	-69	(-77)	-80 (-87)	-108 (-115)		-120 (-126)
≤ 20 GHz	-38 (-45)	-64	(-72)	-74 (-81)		-100 (-108)		-113 (-118)
≤ 30 GHz	-35	-61		-71 -9		-97		-110
≤ 40 GHz	-32	-58		-68		-94		-107
Frequency	100 kHz		1 MH	z	1	0 MHz ¹¹		100 MHz ¹¹
≤ 100 MHz	-132 (-137)		-132 (-137)		-131 (-	138)	N//	Ą
≤ 250 MHz	-133 (-137)		-134 (-138)		-132 (-	139)	-13	32 (-138)
≤ 500 MHz	-133 (-138)		-133 (-139)		-131 (-	139)	-13	31 (-138)
≤ 1 GHz	-133 (-138)		-135 (-139)		-133 (-	140)	-13	32 (-139)
≤ 2 GHz	-134 (-139)		-137 (-141)		-136 (-	143)	-13	35 (-142)
≤ 3.2 GHz	-133 (-138)		-139 (-143)		-137 (-	144)	-13	38 (-144)
≤ 10 GHz	-128 (-133)		-136 (-141)		-140 (-	146)	-13	39 (-146)
≤ 20 GHz	-120 (-125)		-128 (-134)		-133 (-	140)	-13	33 (-140)
≤ 30 GHz	-117		-125		-130		-13	30
≤ 40 GHz	-114		-122		-127		-12	27



 $^{^{\}rm 11}$ Offset only specified when frequency option F32 or F44 is present.

Absolute	SSB phase noise (C	W) (dB	c/Hz) (option S	T5 with F3	2 or F44),	() = typical, ser	ial pi	refix ≥ 6033
Frequency	1 Hz		10 Hz	100	Hz	1 kHz		10 kHz
≤ 100 MHz	-77 (-87)	-98	(-104)	-112 (-117)		-122 (-128)		-129 (-135)
≤ 250 MHz	-70 (-79)	-91	(-98)	-107 (-1	13)	-119 (-125)		-126 (-133)
≤ 500 MHz	-67 (-74)	-86	(-93)	-102 (-1	10)	-128 (-133)		-132 (-139)
≤ 1 GHz	-59 (-67)	-80	(-87)	-92 (-10)1)	-120 (-127)		-131 (-137)
≤ 2 GHz	-55 (-62)	-74	(-81)	-94 (-10	00)	-116 (-123)		-127 (-133)
≤ 3.2 GHz	-51 (-57)	-69	(-76)	-88 (-95	5)	-113 (-119)		-122 (-129)
≤ 10 GHz	-40 (-48)	-60	(-67)	-80 (-86	6)	-103 (-109)		-113 (-120)
≤ 20 GHz	-36 (-42)	-54	(-61)	-69 (-77)		-94 (-102)		-108 (-114)
≤ 30 GHz	-32	-50		-65	-65 -90			-104
≤ 40 GHz	-30	-48		-63		-88		-102
Frequency	100 kHz		1 MHz		10 MHz		100) MHz
≤ 100 MHz	-132 (-138)		-131 (-138)		-130 (-	138)	N//	A
≤ 250 MHz	-132 (-138)		-133 (-139)		-131 (-	140)	-13	30 (-139)
≤ 500 MHz	-133 (-139)		-132 (-139)		-130 (-	139)	-13	30 (-139)
≤ 1 GHz	-133 (-139)		-134 (-140)		-132 (-	141)	-13	30 (-139)
≤ 2 GHz	-133 (-139)		-135 (-142)		-134 (-	142)	-13	34 (-143)
≤ 3.2 GHz	-131 (-137)		-136 (-142)	-142) -		-136 (-144)		-137 (-145)
≤ 10 GHz	-122 (-128)		-131 (-137)		-137 (-	144)	-13	38 (-146)
≤ 20 GHz	-115 (-122)		-125 (-131)		-131 (-	139)	-13	32 (-140)
≤ 30 GHz	-111		-121		-127		-12	28
≤ 40 GHz	-109		-119		-125		-12	26



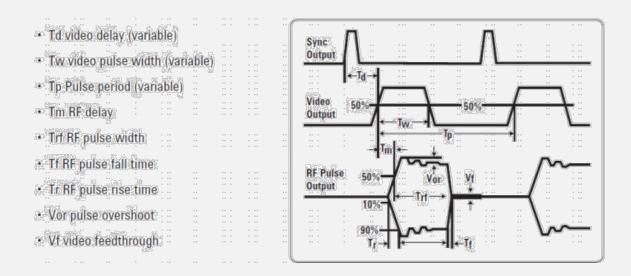
Switching Speed

Frequency switching speed using SCPI						
Mode	Switching speed					
CW mode	< 28 ms (meas.)					
Digital modulation	< 85 ms (meas.)					
Amplitude switching speed using SCPI						
Mode	Switching speed					
CW mode	< 90 ms (meas.)					
Digital modulation	< 140 ms (meas.)					

Pulse Modulation (Option PMR or PME)

Pulse paths						
Internal pulse generator, external input						
М	Minimum pulse width (T _w) with duty cycle \leq 50%					
ALC on	1 μs (nom.)					
ALC off, 10 MHz to 20 GHz	100 ns (nom.)					
ALC off, > 20 GHz	30 ns (nom.)					
	On/off rat	io				
Frequency	Without I/Q modulation (F14/F20 and no 1ES)	Without I/Q modulation (F32/44)	With I/Q modulation			
< 3.2 GHz	88 dB (typ)	87 dB (95 dB typ)	80 dB (nom.)			
3.2 GHz to < 11 GHz	78 dB (typ)	57 dB (66 dB typ)	80 dB (nom.)			
11 GHz to < 12.5 GHz	64 dB (typ)	42 dB (52 dB typ)	80 dB (nom.)			
12.5 GHz to < 17 GHz	72 dB (typ)	47 dB (57 dB typ)	80 dB (nom.)			
17 GHz to < 20 GHz	69 dB (typ)	50 dB (52 dB typ)	80 dB (nom.)			
20 GHz to < 30.8 GHz	-	74 dB (85 dB typ)	80 dB (nom.)			
30.8 GHz to < 44 GHz	-	80 dB (92 dB typ)	80 dB (nom.)			
	Rise/fall times (1	Γ _r and T _f)				
ALC off	14 ns					
Level accuracy relative to CW						
10 MHz to 44 GHz ± 1.2 dB (± 0.5 dB typical)						
	Width accur	racy				
RF width relative to setting ± 16 ns						

	Video feed-through (Vf)	
500 MHz to 4.2 GHz	(380 mV pk-pk typical)	
> 4.2 GHz to 44 GHz	44 mV pk-pk (19 mV pk-pk typical)	
	RF delay (external input to RF output)	
< 20 GHz	< 250 ns (nom)	
> 20 GHz	< 120 ns (nom)	
Pulse overshoot, () = typical		
≤ 400.7 MHz	31% (19%)	
400.7 MH to < 26 GHz	13% (5%)	
26 GHz to 44 GHz	30% (12%)	
	External input level	
RF on	+1 V (nom.)	
RF off	0 V (nom.)	
	External input impedance	
50 Ω (nom.)		



Internal Pulse Generator (Option PMR or PME)

Internal pulse generator				
Modes	Square, adjustable, doublet, pulse train (SCPI only)			
Triggering	Free run, triggered, trigg	ered doublet, gated, exterr	nal pulse	
Square wave rate	(50 MHz)/k from 0.1 Hz t	o 16.66 MHz where k is ar	n integer (nom)	
	Signal	routing		
Signal	M9383B (F44)	M9384B (F14 or F20)	M9384B (F32 or F44)	
External pulse input	M9314B Trig 1	Pulse In	Pulse In	
Pulse video output	M9323A Trig 1	Trig 1	Pulse Video Out	
Pulse sync output	M9323A Trig 2	Trig 2	Pulse Sync Out	
	Tim	ing		
Pulse period (PRI) (Tp)		60 ns to 42 s		
Pulse width (Tw) 30 ns to 41.99 s		30 ns to 41.99 s		
Video delay (Td)	Free run	0 to 42s		
video delay (1d)	Triggered modes	0 to 42s		
Sync trigger		30 ns to 3.99 s		
	Delay 1	0 to 42s		
Pulse doublets	Pulse width 1	30 ns to 41.99 s		
	Delay 2	60 ns to 42s		
Pulse width 2		30 ns to 41.99s		
	Pulse train generator (Option 320, SCPI only)			
Number of pulse patterns		2047		
On/off time range		30 ns to 42 s		

Vector Modulation (Option Dxx)

External I/Q input (option EXT)			
Туре		Differential: I, \overline{I} , Q, \overline{Q}	
Input impedance		50 Ω (nom.)	
External recommended input leve	l	-1 dBm or 0.2 V _{rms} (nom.)	
External input loval range		0.1 V _{rms} minimum	
External input level range		1 V _{peak} maximum	
External I/Q offset		± 50%	
External I/O guadratura akow	< 3.2 GHz	None	
External I/Q quadrature skew	≥ 3.2 GHz	± 20°	
External I/Q gain balance		± 10 dB (nom.)	
	External I/Q input I	oandwidth (option EXT)	
Frequency		I/Q Bandwidth	
1 MHz to < 375 MHz		20% of carrier	
375 MHz to < 550 MHz		200 MHz	
550 MHz to < 750 MHz		300 MHz	
750 MHz to < 1 GHz		400 MHz	
1 GHz to < 1.5 GHz		750 MHz	
1.5 GHz to < 3.2 GHz		1 GHz	
3.2 GHz to 44 GHz		2 GHz	

RF path filters ¹² (nom.)			
Carrier frequency		Filter cut-off frequency	
> 3.2 to 4.3 GHz		5.3 GHz low pass filter	
4.3 to 6.5 GHz		2.5 to 8 GHz high + low pass filter	
6.5 to 11 GHz		5 GHz to 12.5 GHz high + low pass filter	
11 to 19.5 GHz		8 GHz to 21 GHz high + low pass filter	
19.5 to 22.3 GHz		18.5 to 23.3 GHz bandpass + low pass filter	
22.3 to 25.1 GHz		21.3 to 26.1 GHz bandpass + low pass filter	
25.1 to 28.5 GHz		24.1 to 29.5 GHz bandpass filter	
28.5 to 30 .5 GHz		27.5 to 31.5 GHz bandpass filter	
30.5 to 32.9 GHz		29.5 to 33.9 GHz bandpass filter	
32.9 to 35.3 GHz		31.9 to 36.3 GHz bandpass filter	
35.3 to 38 GHz		34.3 to 39 GHz bandpass filter	
38 to 40.4 GHz		37 to 41.4 GHz bandpass filter	
40.4 to 44 GHz		39.4 to 45 GHz bandpass filter	
	Internal I/Q b	aseband generator adjustments	
Internal I and Q offse	t	± 20% (nom.)	
Internal I/Q quadratu	re skew	± 20° (0.001° resolution)	
Internal I/Q gain bala	nce	± 10 dB (nom.) (0.001 dB resolution)	
Internal I/Q time skew	V	± 19.5 ns (1 ps resolution)	
Fine I/Q delay range		0 to 1.589609 μs	
Fine I/Q delay resolution	tion	1 ps	
	I/Q bas	eband output (option DIQ)	
Туре		Single-ended, differential: I, \overline{I} , Q, \overline{Q}	
Output impedance	Single ended	50 Ω (nom.)	
	Differential	100 Ω (nom.)	
Frequency range		DC to 1 GHz (nom.) for < 1 dB bandwidth	
Common-mode I/Q o	ffset	± 200 mV (0.001 mV resolution)	
Differential mode I or	Q offset	± 50 mV (0.001 mV resolution)	

¹² The IF filter cut off is 10.5 GHz when upconverting above 19.5 GHz. When above 19.5 GHz and center frequency f < 28.5 GHz, the IF is $\frac{f}{3}$. For f ≥ 28.5 GHz, the IF is $\frac{f}{5}$. Therefore, modulation bandwidth is limited by how close $\frac{f}{3}$ or $\frac{f}{5}$ is to the cutoff of 10.5 GHz IF filter. For example, at 21 GHz, the IF is centered at $\frac{21}{3}$ = 7 GHz, which provides 3.5 GHz overhead since 10.5 – 7 = 3.5.

I/Q baseband output amplitude ¹³		
Internal I/Q	Single ended	0 V_{pp} to 0.8 V_{pp}
modulation	Differential	0 V_{pp} to 1.6 V_{pp}
I/Q baseband output spectral purity		
SFDR (sine)	10 MHz tone	-75 dBc (measured)
SFDR (Sille)	500 MHz tone	-66 dBc (measured)
Noise floor	100 MHz tone measured at 133 MHz	≤ -159 dBm/Hz (measured)
Phase noise	100 MHz tone, 10 MHz offset	-162 dBc/Hz (measured)

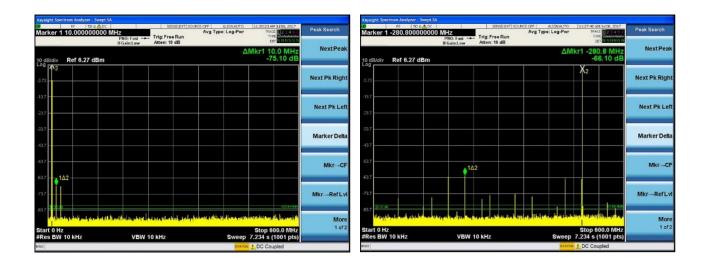


Figure 3: (Left) Measured IQ output, 10 MHz tone spectrum. (Right) Measured IQ output, 500 MHz tone spectrum.

¹³ At maximum sample rate. Reducing sample rate will allow for higher amplitude settings.

	Internal rea	al-time complex digital I/Q filters	
Factory channel cor		phase and amplitude response of the baseband I/Q and RF outputs of rator using factory calibration arrays.	
	1 GHz bandwidth $< \pm 0.7$ dB (nom.)		
RF amplitude flatness	1.6 GHz bandwidth	< ± 0.7 dB (nom.)	
natioso	2 GHz bandwidth	< ± 0.9 dB (nom.)	
User defin	ed automatic channel respor	nse correction and S-parameter de-embedding (N7653APPC)	
	Metho	ds for fixture error removal	
Scatter parameter	s de-embedding/embedd	ing files generated by a network analyzer or simulation	
Automatic channel response correction using a power sensor or spectrum analyzer (amplitude and phase correction)			
Scaler user flatness (absolute power correction)			
Scatter parameters			
File format .s2p, .csv			
Number of cascad	Number of cascadeable calibration sets 4		
	Automated char	nnel response correction (128 taps) ¹⁴	
Recommended maximum amplitude for error correction ± 15 dB		± 15 dB	
Recommended maximum phase error for ± 25°		± 25°	
		User flatness	
File format		.uflat, .csv	
Entry modes US		USB or LAN direct power meter control	

¹⁴ Automated routine uses power sensor to correct for linear phase and amplitude response of DUT (equalizer). See User Documentation for more details.

Internal Baseband Generator (Option Dxx)

		nternal baseban	d ae	enerator (option Dxx)	
Channels				phase (I), quadra		
DAC resolution			16 bits [1/65536]			
Waveform granularity			samples			
wavelenni granalanty	Option D0	5 or D06		Hz to 625 MHz		
	Option D1			Hz to 1.28 GHz		
Sample rate	Option D1		-			
	D2E ¹⁵	0, D21, 01	1	Hz to 2.56 GHz		
Same rate resolution				Hz		
Interpolated DAC rate)		4	ixed 2.56 GHz		
		RF (I +	Q)	bandwidth		
Frequency		Option D05 ar D06	nd	Option D10 and D11	Option D20 and D21	Option D2E
1 MHz to < 375 MHz		20% of carrie	er	20% of carrier	20% of carrier	20% of carrier
375 MHz to < 550 MH	lz	200 MHz		200 MHz	200 MHz	200 MHz
550 MHz to < 750 MH	łz	300 MHz		300 MHz	300 MHz	300 MHz
750 MHz to < 1 GHz		400 MHz		400 MHz	400 MHz	400 MHz
1 GHz to < 1.5 GHz		500 MHz		750 MHz	750 MHz	750 MHz
1.5 GHz to < 3.2 GHz	,	500 MHz		1 GHz	1 GHz	1 GHz
3.2 GHz to < 31.35 G		500 MHz		1 GHz	2 GHz	2 GHz
31.35 GHz to < 31.85		500 MHz		1 GHz	2 GHz	1 GHz
31.85 GHz to 36.95 GHz		500 MHz		1 GHz	2 GHz	550 MHz
> 36.95 GHz to 37.45 GHz		500 MHz		1 GHz	2 GHz	1 GHz
> 37.45 GHz to 44 GH		500 MHz		1 GHz	2 GHz	2 GHz
			Nave	eform memory		
				56 MSa (standard)	
Maximum arbitrary waveform playback			12 MSa (option M	,		
memory			024 MSa (option I			
Maximum storage cap	pacity			6 GB shared with		s (nom.)
				gers	operating operatin	
Trigger types				ontinuous, single		
Trigger sources			Trigger key, external, bus (LAN, GPIB)			
Thyger sources	Continuo		Free run, trigger & run, reset & run			
Trigger modes	Single	u3	Buffered trigger, no retrigger, restart on trigger			
· · · · · · · · · · · · · · · · · · ·		0 to 10 s				
Coarse trigger delay range Coarse trigger delay resolution		3.125 ns				
Coarse ingger delay resolution		See Internal I/Q baseband adjustment generator				
Fine I/Q delay range		section				
Fine I/Q delay resolut	ion			ee Internal I/Q ba ection	seband adjustme	nt generator
Trigger jitter				3.125 ns (320 MF	Iz trigger sample	rate)
Trigger latency with c	orrection filte	er on	1086 ns + (21 × sample clock in ns) + RF path latency			
Trigger RF electrical I	atency			ariable depending	i on attenuator pa	th and cabling
Thyger RF electrical latency			V	anabie depending	, on allonualor pa	an and cabinity

¹⁵ Option D2E maximum sample rate is frequency dependent.

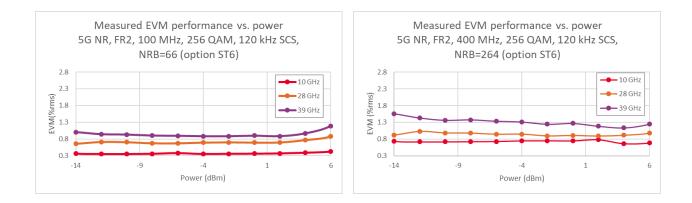
Mul	ti-channel baseband s	ynchronization primary/secondary (option PCH)	
Trigger types		Continuous, single	
Trigger sources		Trigger key, external, bus (LAN, GPIB)	
Continuous		Free run, trigger & run, reset & run	
Trigger modes	Single	Buffered trigger, no retrigger, restart on trigger	
Global coarse trigger c	lelay range ¹⁶	0 ns to 12 s	
Global coarse trigger o	lelay resolution ¹⁶	3.125 ns	
Global trigger jitter		± 50 ns (nom.) relative to asynchronous external system trigger event	
Relative trigger repeat	ability	± 5 ps (nom.)	
Relative trigger repeat	ability after power	± 25 ps (nom.)	
Relative fine I/Q delay	range	Delay of channel 1 relative to channel 2. See Internal I/Q baseband adjustment generator section.	
Relative fine I/Q delay resolution		Delay of channel 1 relative to channel 2. See Internal I/Q baseband adjustment generator section.	
Relative phase adjust range		See Frequency section	
Relative phase adjust resolution		See Frequency section	
Relative phase repeata	ability	See Frequency section	
Trigger latency with co	rrection filter on	1642.25 ns + (21 \times sample clock in ns) + RF path latency	
Trigger RF electrical la	itency	Variable depending on attenuator path and cabling	
		Markers	
		he waveform generation process. A marker can also be output. See User's Documentation for more information.	
Marker polarity		Positive	
Number of markers		4	
RF blanking/burst or o	n/off ratio	> 80 dB (nom.)	
		< 250 ps (nom.) (sample rate is a submultiple of 2.56 GHz)	
Marker to waveform jitter		< 3.125 ns (nom.) (sample rate is not a submultiple of 2.56 GHz)	

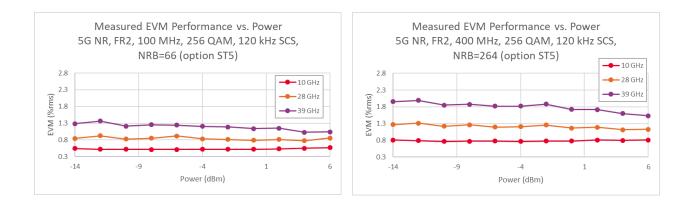
¹⁶ For channel 1 and channel 2 together.

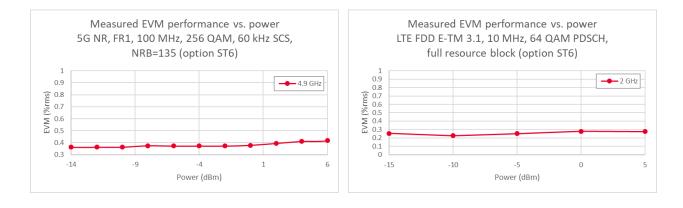
Error Vector Magnitude (EVM)

EVM for 5G NR FR2 bands and IFs, -14 dBm to +6 dBm (nom.) ¹⁷ , option ST6					
Frequency	100 MHz, 256QAM, 120 kHz SCS, NRB = 66 or 5GTF	400 MHz, 256QAM, 120 kHz SCS, NRB = 264			
3.4 GHz	0.35%	0.65%			
10 GHz	0.42%	0.73%			
12 GHz	0.43%	0.71%			
24.5 GHz	0.85%	1.50%			
28 GHz	0.96%	1.60%			
39 GHz	1.42%	1.86%			
42.5 GHz	1.97%	2.10%			
EVM fo	EVM for 5G NR FR1 bands, -14 dBm to +6 dBm (nom.) ¹⁷ , option ST6				
Frequency	100 MHz, 256QAM, 60 kHz SCS, NRB = 135				
2.3 GHz	0.49%				
3.55 GHz	0.47%				
4.9 GHz	0.37%				
EVM for LTE, -15 dBm to +5 dBm (nom.) ¹⁷ , option ST6					
Frequency	LTE FDD E-TM 3.1,10 MHz, 64 QAM PDSCH, full resource block				
2 GHz	2 GHz				

¹⁷ Measured EVM after DC calibration.

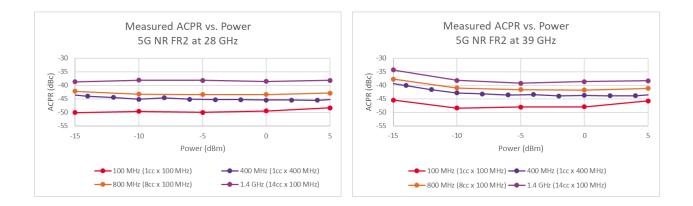


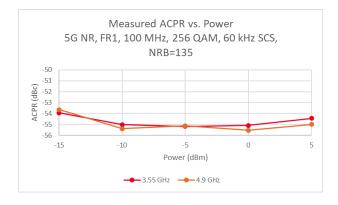




Adjacent Channel Power Ratio (ACPR)

ACPR for 5G NR FR2 bands and IFs, -15 dBm to +5 dBm (nom.)				
Frequency	100 MHz, 256QAM, 120 kHz SCS, NRB = 66	400 MHz, 256QAM, 120 kHz SCS, NRB = 264 ¹⁸	8cc x 100 MHz (800 MHz), 256QAM, 120 kHz SCS, NRB = 66 or 5GTF	14cc x 100 MHz (1.4 GHz), 256QAM, 120 kHz SCS, NRB = 66
10 GHz	-53 dBc	-48 dBc	-45 dBc	-41 dBc
24.5 GHz	-49 dBc	-45 dBc	-42 dBc	-38 dBc
28 GHz	-48 dBc	-44 dBc	-42 dBc	-38 dBc
39 GHz	-45 dBc	-40 dBc	-37 dBc	-34 dBc
42.5 GHz	-42 dBc	-37 dBc	-35 dBc	-32 dBc
	ACPR for 5G NI	R FR1 bands, -15 dBm to	+5 dBm (nom.)	
Frequency	100 MHz, 256QAM, 60 kHz SCS, NRB = 135			
2.3 GHz	-51 dBc			
3.55 GHz	-53 dBc			
4.9 GHz	-53 dBc			





¹⁸ Over power range -14 dBm to +6 dBm.

Remote Programming

Remote programming		
Software drivers	IVI.NET	
Interfaces	GPIB (IEEE-488.2,1987) with listen and talk, and 1000BaseT LAN interface	
Control languages	SCPI version 1999.0	
IEEE-488 functions	SH1, AH1, T6, TE0, L4, LE0, SR1, RL1, PP0, DC1, DT0, C0, E2	
Keysight IO libraries	Keysight's IO Library Suite helps you quickly establish an error-free connection between your PC and instruments – regardless of the vendor. It provides robust instrument control and works with the software development environment you choose.	

Environmental Specifications

Environmental specifications and regulatory compliance			
Temperature	Operating	0 to 45 °C (single channel), 0 to 40 °C (dual channel)	
remperature	Storage	-40 to +70 °C	
Humidity		Type tested at 95%, +40 °C (non-condensing) (From 40°C to 45°C, the maximum % relative humidity follows the line of constant dew point.)	
	Operating random vibration	Type tested at 5 to 500 Hz, 0.21 g rms	
Shock/Vibration	Survival random vibration	Type tested at 5 to 500 Hz, 2.09 g rms	
	Functional shock	Type tested at half-sine, 30 g, 11 ms	
	Bench handling	Type tested per MIL-PRF-28800F	
Altitude	Operating	3,000 m (Up to 10,000 feet approx.)	
Annude	Storage	4,572 m (Up to 15,000 feet)	
EMC		Complies with European EMC Directive – IEC/EN 61326-1 – CISPR Pub 11 Group 1, class A – AS/NZS CISPR 11 – ICES/NMB-001 This ISM device complies with Canadian ICES-001. Cet appareil ISM est conforme a la norme NMB-001 du Canada.	
Environmental testing		Samples of this product have been type tested in accordance with the Keysight Environmental Test Manual and verified to be robust against the environmental stresses of storage, transportation and end-use. Those stresses include but are not limited to temperature, humidity, shock, vibration, altitude and power-line conditions. Test methods are aligned with IEC 60068-2 and levels are similar to MIL- PRF-28800F Class 3.	

M9384B VXG General Specifications

Physical specifications				
	Single channel (F14 or F20)	29 kg (63.2 lbs.)		
Maight	Single channel (F32 or F44)	30 kg (66 lbs.)		
Weight	Dual channel (F14 or F20)	32 kg (71.2 lbs.)		
	Dual channel (F32 or F44)	35 Kg (77.2 lbs.)		
Dimensions (L x	W x H)	578 mm x 445 mm x 190 mm (approx.)		
Maximum power consumption (typical)				
Single channel		640 W		
Dual channel		1000 W		
Display				
Resolution		1280 x 768 pixels		
Size		10.6 in (26.9 cm) diagonal		
Data storage				
Internal		Removable solid state drive (240 GB)		
External		Supports USB 3.0/2.0 compatible memory devices		

M9384B VXG Input and Output Connectors

Front panel connectors			
Connectors	Туре	Description	
19.2 GHz Out 1	SMA female	Output of 19.2 GHz CW frequency reference, cabled from the factory to 19.2 GHz In. This port is always-on level is 7.3 dBm (nominal), if alternate 19.2 GHz In is provided this port should be terminated with 50 Ω load.	
19.2 GHz Out 2	SMA female	Output of 19.2 GHz CW frequency reference switched from user interface; off by default. High impedance when off, 50 Ω when on, level is 7.3 dBm (nominal).	
100 MHz Out	SMB male	Output of 100 MHz CW frequency reference, switched from the user interface; off by default. High impedance when off, 50 Ω when on, level is +15 dBm (nominal).	
Trig 1	SMB male	For options F32/F44, reserved for future use. For options F14/F20 with options PME/PMR Pulse Video Out outputs signal following envelope of RF pulse. Instruments with option 002 have connector for CH2.	
Trig 2	SMB male	For options F32/F44, reserved for future use. For options F14/F20 with options PME/PMR Pulse Sync Out outputs signal (trigger) related to pulse timing. VOL < 0.4 V, VOH is 2.8 V to 3.3 V into high impedance. 50 Ω impedance (nominal). Damage level is ± 5 V. Instruments with option 002 have connector for CH2.	

Settled	SMB male	Output signal to determine when the signal level is settled: logic High while settled and low (approximately 0v) when change is in progress. CMOS +3.3 V Logic. Damage level is < -5 V and > 6.5 V. Instruments with option 002 have connector for CH2.	
EFC In	SMB male	Reserved for future use. ESD damage level is 30 V.	
LF1 Out	SMB male	Reserved for future use.	
AM In	BNC female	Reserved for future use. 50 Ω impedance (nominal). Damage level is 10 V peak, 5 V rms. Instruments with option 002 have connector for CH2.	
Pulse In	BNC female	For options PME/PMR externally provided Pulse modulation signal. 1 M Ω impedance (nominal). Damage level is 10 V peak, 5 V rms. Instruments with option 002 have connector for CH2.	
Pulse Video Out	SMB male	For options F32/F44 with options PME/PMR, outputs signal following envelope of RF pulse. VOL < 0.4 V, VOH is 2.8 V to 3.3 V into high impedance. 50 Ω impedance (nominal). Damage level is ± 5 V. Instruments with option 002 have connector for CH2.	
Pulse Sync Out	SMB male	For options F32/F44 with options PME/PMR, outputs signal (trigger) related to pulse timing. VOL < 0.4 V, VOH is 2.8 V to 3.3 V into high impedance. 50 Ω impedance (nominal). Damage level is ± 5 V. Instruments with option 002 have connector for CH2.	
RF Out 1/2	Option F32/F44 – 2.4 mm male Option F14/F20 – APC 3.5 mm male		
CH1 +I Out	SMA female	Analog in-phase component of I/Q modulation from channel 1's internal baseband generator. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is ± 2 V.	
CH2 I Out	SMA female For instruments with option 002, outputs the in-p component of channel 2's analog I/Q modulation range is DC to 1000 MHz (nominal). 50 Ω imped (nominal). Damage level is ± 2 V.		
CH1 -I Out	SMA female	Analog in-phase component of I/Q modulation from channel 1's internal baseband generator, 180° out of phase from +I Out. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is ± 2 V.	
CH1 +Q Out	SMA female	Analog quadrature-phase component of I/Q modulation from channel 1's internal baseband generator. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is ± 2 V.	
CH2 Q Out	SMA female	For instruments with option 002, outputs the quadrature component of channel 2's analog I/Q modulation. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is ± 2 V.	

CH1 -Q Out	SMA female	Analog quadrature-phase component of I/Q modulation from channel 1's internal baseband generator, 180° out of phase from +Q Out. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is ± 2 V.
CH1 I+ In	SMA female	For option EXT, externally supplied analog in-phase component of I/Q modulation to channel 1's internal baseband generator. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms.
CH2 I In	SMA female	For option EXT and option 002, input for in-phase component of channel 2's analog I/Q modulation. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms.
CH1 I- In	SMA female	For option EXT, externally supplied analog in-phase component of I/Q modulation to channel 1's internal baseband generator, 180° out of phase from I+ In. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms.
CH1 Q+ In	SMA female	For option EXT, externally supplied analog quadrature-phase component of I/Q modulation to channel 1's internal baseband generator. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms.
CH2 Q In	SMA female	For option EXT and option 002, input for quadrature component of channel 2's analog I/Q modulation. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms.
CH1 Q- In	SMA female	For option EXT, externally supplied analog quadrature-phase component of I/Q modulation to channel 1's internal baseband generator, 180° out of phase from Q+ In. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms.
19.2 GHz In	SMA female	Input for 19.2 GHz CW frequency reference required for instrument operation. +5 dBm (nominal). 50 Ω impedance (nominal). Damage level is +20 dBm.
BBG Sync	SMA female	Reserved for future use. In instruments with option 002 this is a wired-or of the two channels.
Ctrl M	uHDMI female	Reserved for future use. Damage level is < -5 V and > 6.5 V.
Ctrl S	uHDMI female	Reserved for future use. Damage level is < -5 V and > 6.5 V.
USB 3.0	USB Type-A female	Host controller, SuperSpeed, 900 mA (nominal)
USB 2.0	USB Type-A female	Host controller, high-speed, 1.2 A (nominal)
Display Port	DisplayPort	For external display devices. Display Port Dual Mode DisplayPort++ (DVI-D, VGA, HDMI with an adapter). NOTE: To duplicate the instrument's application on an external display it is recommended to set the resolution to 1280x768.

Power switch		Turns the instrument on and off.
Power Green LED		Indicates power is on.
Power Yellow LED		Indicates AC power is connected and some internal circuitry is live.
		Rear panel connectors
Connectors	Туре	Description
10 MHz In	BNC female	Externally supplied 10 MHz CW frequency reference, switched by the user interface; off by default. Input level -3 dBm to +20 dBm (nominal), 50 Ω impedance. ESD damage level is 30 V.
10 MHz Out	BNC female	Output of 10 MHz CW frequency reference, this port is always on. +15 dBm (nominal). 50 Ω impedance (nominal). ESD damage level is 30 V.
100 MHz Out	SMA female	Output of 100 MHz CW frequency reference, cabled from the factory to EXT CLK IN. This port is always-on level is +15 dBm (nominal). If alternate EXT CLK IN is provided this port should be terminated with 50 Ω load. Connector for CH1 and CH2.
CH1 EXT 1	BNC female	External baseband generator trigger input for channel 1. 10 k Ω input impedance (nominal). Damage level is ± 5 V.
CH2 EXT 1	BNC female	External baseband generator trigger input for channel 2. 10 k Ω input impedance (nominal). Damage level is ± 5 V. Unused if option 002 is not present.
CH1 SYNC OUT	BNC female	Output of TTL High as assigned to Signal's Marker Setup for channel 1. VOL < 0.4 V, VOH is 2.8 V to 3.3 V into high impedance. 50 Ω impedance (nominal). Damage level is ± 5 V.
CH2 SYNC OUT	BNC female	Output of TTL High as assigned to Signal's Marker Setup for channel 2. VOL < 0.4 V, VOH is 2.8 V to 3.3 V into high impedance. 50 Ω impedance (nominal). Damage level is ± 5 V. Unused if option 002 is not present.
EXT CLK IN	SMA female	Input of an external 100 MHz reference clock required for instrument operation. +10 dBm (nominal). 50 Ω impedance (nominal). Damage level is +20 dBm. One per channel, channel 2 is unused if option 002 is not present.
GPIB	Micro-D 25-pin	IEEE-488.2, 1987 with listen and talk. Use accessory Y1260A for GPIB cabling.
LAN	RJ45 Ethertwist	GbE 10/100/1000BASE-T Ethernet: the LAN supports DHCP, connection monitoring, dynamic hostname services, TCP/IP communication, TCP keep alive, and SCPI remote programming.

M9383B VXG-m Physical Specifications

Physical Specifications				
Module	Size Dimensions (L x W x H) Weight		Weight	
M9312B	3 PXIe slots	205	5 mm x 61.8 mm x 130 mm	1.9 kg (4.2 lbs.)
M9314B	1 PXIe slot	205	5 mm x 21.2 mm x 130 mm	0.6 kg (1.4 lbs.)
M9323A	1 PXIe slot	205	5 mm x 21.2 mm x 130 mm	0.6 kg (1.4 lbs.)
M9343A	3 PXIe slots	205	5 mm x 61.8 mm x 130 mm	1.6 kg (3.6 lbs.)
M9347A	1 PXIe slot	205	5 mm x 20.2 mm x 130 mm	0.7 kg (1.6 lbs.)
Maximum power consumption (typical)				
Single channel		630 W		
Dual channel		990 W		

M9383B VXG-m Input and Output Connectors

M9312B			
Connectors	Туре	Description	
4.8 GHz In	APC female (3.5 mm)	Inputs a 4.8 GHz reference clock from the M9043A Chassis 4.8 GHz Out 1 connector.	
4.8 GHz Out	APC female (3.5 mm)	Outputs a copy of 4.8 GHz signal accepted by the 4.8 GHz In connector.	
LO 2 Out	APC female (3.5 mm)	Outputs either a copy of LO 1 In signal or a doubled copy of LO 1 In signal (selectable) to the M9314B LO 1 In connector.	
100 MHz In	SMP male	Inputs a 100 MHz reference signal from the M9043A Chassis 100 MHz Out 3 connector.	
100 MHz Out	SMP male	Outputs a copy of the 100 MHz reference signal (received by 100 MHz In connector) to the M9347A Ref In connector.	
LF Out	SMP male	Outputs a waveform from the internal function generator or a copy of the AM modulated signal.	
AM In	SMP male	Reserved for future use. 0 to 1 MHz (nominal). 1.0 V (nominal) for 100% AM. 1 M Ω impedance (nominal). Damage level is ± 15 V.	
Trig 1	SMP male	Accepts a bi-directional trigger signal from the M9343A Ext 2 connector.	
Trig 2	SMP male	Accepts a bi-directional trigger signal from the M9314B Trig 2 connector.	
Sync Out	SMP male	Accepts a bidirectional signal used for synchronization with other modules.	
LO 1 In	SMA female	Accepts an LO signal between 400 MHz and 10 GHz from the M9347A Synth 1 Out connector.	

LO 1 Out	SMA female	Outputs either a copy of LO 1 In signal or a doubled copy of LO 1 In signal (selectable) to the M9343A LO 1 In connector.
RF Out	Female (2.4 mm)	Outputs an RF signal between 1 MHz and 20 GHz to the M9323A RF In connector when Aux Out is connected to Aux In. Otherwise, outputs the signal to the Aux Out connector attenuated by the selected attenuation value.
Aux In	SMA female	Accepts an input signal between 1 MHz to 44 GHz from the M9314B Aux Out connector.
Aux Out	SMA female	Provides an output signal to the M9314B Aux In connector.
RF 2 In	SMA female	Inputs an IF signal between 400 MHz and 3.2 GHz from the M9343A RF 2 Out connector.
RF 1 In	SMA female	Inputs an IF signal between 3.2 GHz and 20 GHz from the M9314B RF 1 Out connector.
		M9314B
Connectors	Туре	Description
Trig 1	SMP male	For options PME/PMR externally provided Pulse modulation signal. 1 M Ω impedance (nominal). Damage level is 10 V peak, 5 V rms.
Trig 2	SMP male	Outputs the trigger signal to the M9312B Trig 2 connector.
Sync	SMP male	Accepts a bidirectional signal used for synchronization with other modules.
AM In	SMP male	Accepts an external amplitude modulated signal with 50%/volt or 20 dB/volt (selectable).
AM Out	SMP male	Reserved for future use. 50 Ω impedance (nominal). Damage level is 10 V peak, 5 V rms.
LO 1 In	Female (2.4 mm)	Inputs an LO signal between 22 GHz and 38 GHz from the M9312B LO 2 Out connector.
RF 1 Out	SMA female	Outputs a copy of the RF 1 In signal to the M9312B RF 1 In connector.
RF 1 In	SMA female	Inputs the IF signal between 400 MHz and 20 GHz from the M9343A RF 1 Out connector.
Aux In	SMA female	Accepts an input signal between 1 MHz and 20 GHz from the M9312B Aux Out connector.
Aux Out	Female (2.4 mm)	Provides a RF output as either the upconverted signal from RF 1 In connector or the Aux In signal to the M9312B Aux In connector.

		M9323A	
Connectors	Туре	Description	
Trig 1	SMP male	For options F32/F44 with options PME/PMR, outputs signal following envelope of RF pulse. VOL < 0.4 V, VOH is 2.8 V to 3.3 V into high impedance. 50 Ω impedance (nominal). Damage level is ± 5 V.	
Trig 2	SMP male	For options F32/F44 with options PME/PMR, outputs signal (trigger) related to pulse timing. VOL < 0.4 V, VOH is 2.8 V to 3.3 V into high impedance. 50 Ω impedance (nominal). Damage level is ± 5 V.	
Sync	SMP male	Accepts a bidirectional signal used for synchronization with other modules.	
RF 1 Out	Female (2.4 mm)	RF Output signal, level selected by user interface. 50 Ω impedance (nominal).	
RF 1 In	Female (2.4 mm)	Accepts a RF signal from the M9312B RF Out connector.	
		M9343A	
Connectors	Туре	Description	
Sync	SMB male	Intended for future use.	
Ext 1	SMB male	External trigger input. 10 k Ω input impedance (nominal). Damage level is ± 5 V.	
Ext 2	SMB male	Outputs the trigger signal to the M9312B Trig 1 connector.	
Ext Clk In	SMB male	Inputs a 100 MHz signal from the M9043A Chassis 100 MHz Out 4 connector.	
Aux Port		Reserved for future use.	
USB Port		Reserved for future use. Not for use with USB devices.	
I+ Input	SMP male	For option EXT, externally supplied analog in-phase component of I/Q modulation to internal baseband generator. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms.	
I- Input	SMP male	For option EXT, externally supplied analog in-phase component of I/Q modulation to internal baseband generator, 180° out of phase from I+ In. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms."	
Q+ Input	SMP male	For option EXT, externally supplied analog quadrature-phase component of I/Q modulation to internal baseband generator. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms.	
Q- Input	SMP male	For option EXT, externally supplied analog quadrature-phase component of I/Q modulation to internal baseband generator, 180° out of phase from Q+ In. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is 5 V peak, 1 V rms.	
I+ Output	SMP male	Analog in-phase component of I/Q modulation from internal baseband generator. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is ± 2 V.	

I- Output	SMP male	Analog in-phase component of I/Q modulation from internal baseband generator, 180° out of phase from +I Out. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is ± 2 V.	
Q+ Output	SMP male	Analog quadrature-phase component of I/Q modulation from internal baseband generator. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is ± 2 V.	
Q- Output	SMP male	Analog quadrature-phase component of I/Q modulation from internal baseband generator, 180° out of phase from +Q Out. Frequency range is DC to 1000 MHz (nominal). 50 Ω impedance (nominal). Damage level is ± 2 V.	
Trig 1	SMP male	Output of TTL High as assigned to Signal's Marker Setup. VOL < 0.4 V, VOH is 2.8 V to 3.3 V into high impedance. 50 Ω impedance (nominal). Damage level is ± 5 V.	
Trig 2	SMP male	For options F32/F44, reserved for future use. For options F14/F20 with options PME/PMR Pulse Sync Out outputs signal (trigger) related to pulse timing. VOL < 0.4 V, VOH is 2.8 V to 3.3 V into high impedance. 50 Ω impedance (nominal). Damage level is ± 5 V."	
Sync	SMP male	Used for option PCH, phase coherency.	
LO 2 In	SMA female	Accepts a LO signal between 400 MHz and 3.2 GHz for use by the 400 MHz to 3.2 GHz modulator.	
LO 2 Out	APC female (3.5 mm)	Outputs a copy of the LO 1 In signal to the M9343A LO 2 In connector.	
RF 2 Out	SMA female	Outputs a modulated RF signal from the 0.4 to 3.2 GHz modulator. This signal is routed to the M9312B RF 2 In connector.	
LO 1 In	APC female (3.5 mm)	Accepts a LO signal between 0.4 and 20 GHz that can be used by the 3.2 to 20 GHz modulator. The range from 0.4 to 3.2 GHz is only usable by the LO 2 Out connector.	
RF 1 Out	APC female (3.5 mm)	Outputs a modulated RF signal from the 3.2 to 20 GHz modulator to the M9314B RF 1 In connector. Output can be switched on or off.	
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Connectors	Туре	Description	
Synth 2 Out	SMA female	For Dual Channel configuration, this connector outputs a synthesized signal to the M9312B LO 1 In connector.	
Clock In	SMA female	Accepts a 4.8 GHz or 19.2 GHz signal from the M9043A Chassis 19.2 GHz Out 2 connector.	
Ref Out	SMA female	Outputs a 100 MHz, 4.8 GHz or 19.2 GHz clock signal.	
Ref In	SMP male	Accepts a 100 MHz signal from the M9312B 100 MHz Out connector.	
Synth 1 Out	SMA female	Outputs a synthesized signal to the M9312B LO 1 In connector.	
Mark 1	SMP male	Output signal to determine when the signal level is settled: logic High while settled and low (approximately $0v$) when change is in progress. CMOS +3.3 V Logic. Damage level is < -5 V and > 6.5 V.	
Mark 2	SMP male	For instruments with option 002, channel 2's output signal to determine when the signal level is settled: logic High while settled and low (approximately 0v) when change is in progress. CMOS +3.3 V Logic.	
		Damage level is < -5 V and > 6.5 V.	
Ctrl M	uHDMI female	Reserved for future use. Damage level is < -5 V and > 6.5 V.	

		M9043A
Connectors	Туре	Description
HF Out 1	SMA (f)	Output of 19.2 GHz CW frequency reference, switched from user interface; off by default. High impedance when off, 50 Ω when on, level is 7.3 dBm (nominal).
Trig 1	SMB (m)	For options F32/F44, reserved for future use. For options F14/F20 with options PME/PMR Pulse Video Out outputs signal following envelope of RF pulse.
Trig 2	SMB (m)	For options F32/F44, reserved for future use. For options F14/F20 with options PME/PMR and option 002, channel 2's Pulse Video Out outputs signal following envelope of RF pulse.
Ref In	SMB (m)	Externally supplied 10 MHz CW frequency reference, switched by the user interface; off by default. NOTE: When using an external frequency reference this connector is preferred over the M9043A Rear Panel 10 MHz IN. Input level -3dBm to +20 dBm (nominal), 50 Ω impedance. ESD damage level is 30 V.
EFC/Cal In	SMB (m)	Reserved for future use. ESD damage level is 30 V.
OCXO/Cal Out	SMB (m)	Output of 10 MHz CW frequency reference, this port is always on. NOTE: When using the frequency reference to provide frequency lock with another instrument this connector is preferred over the M9043A Rear Panel 10 MHz OUT. +15 dBm (nominal). 50 Ω impedance (nominal). ESD damage level is 30 V.
100 MHz Out 1	SMB (m)	Output of 100 MHz CW frequency reference, cabled from the factory to M9343A Ext Clk In. This port is always-on level is +15 dBm (nominal). If alternate M9343A Ext Clk In is provided this port should be terminated with 50 Ω load.
100 MHz Out 5	SMB (m)	Output of 100 MHz CW frequency reference, switched from the user interface; off by default. High impedance when off, 50 Ω when on, level is +15 dBm (nominal).
Temp	LED indicator	Green = functioning properly. Red = fault condition.
Fan	LED indicator	Green = functioning properly. Red = fault condition.
Power	Power Switch	Turns the instrument on and off.

Setup and Calibration Services

Assistance	
One day startup assistance	Gain access to a technical expert who will help you get started quickly with the VXG Microwave Signal Generator and its powerful software tools. The flexible instruction format is designed to get you to your first measurements and familiarize you with ways to adapt the equipment to a specific application. Included in base configuration.
Calibration and traceability	
Calibration cycle	A one-year calibration cycle is recommended.

Support and Warranty

Warranty		
Global warranty	Keysight's warranty service provides standard coverage for the country where product is used.	
	All parts and labor necessary to return to full specified performance	
	Recalibration for products supplied originally with a calibration certificate	
	Return shipment	
Support		
Self-test utility	A self-test utility runs a set of internal tests which verifies the health of the modules and reports their status.	

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